IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	© Copyright 2005, IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						Mfg In	formation	1		
Supplier Info	rmation															
Company name*		Company un	Company unique ID			Unique ID Authority					Response Date*					
nsemi													2024-05-03			
Contact Name		Title - Contact			I	Phone - Contact*				Email	Email - Contact*					
Product-Env-Ste	ewards	Product Enviro Compliance			1	NA				Prod	Product-Env-Stewards@onsemi.com					
authorized Repro	esentative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*					
Product-Env-Ste	ewards	Product Enviro Compliance]	NA				Prod	Product-Env-Stewards@onsemi.com					
Reque	ester Item Number	r Item Number Mfr Item Number NC7SV05L6X		Mfr Item Name			Effective Dat	e Version	Version Manufacturing Site		ite	Weight*		UOM	Unit Type	
				ULP-A Inverter O/D			2024-05-03 TH2		H2		2.208		mg	Each		
Ianufacturin	ng Proccess Informatio	on								_						
Termin	nal Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	SL Rating	Peak Pro	Peak Process Body Temperature		e Max Time a	Peak Temper	ak Temperature Number of Reflow C		of Reflow Cyc	eles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С	30	sec	onds	3			
Comments					·	·										
vel 1 - maximun	n time at peak temperature	during so	ldering is 10-3	0 seconds		·										
or more informa	ation regarding material co	mposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Die Attach	0.052	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0309	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0211	mg
Lead Frame	0.77		Supplier	Magnesium (Mg)	7439-95-4		0.001	mg
			Supplier	Silicon (Si)	7440-21-3		0.006	mg
			В	Nickel (Ni)	7440-02-0		0.025	mg
			Supplier	Copper (Cu)	7440-50-8		0.738	mg
Mold Compound-Black	1.295		Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0717	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0029	mg
			Supplier	Silica (SiO2)	14464-46-1		1.1748	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0456	mg
Plating	0.011	mg	Supplier	Palladium (Pd)	7440-05-3		0	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Gold (Au)	7440-57-5		0.001	mg
Wire Bond - Au	0.04	mg	Supplier	Gold (Au)	7440-57-5		0.04	mg